chedule A: Project 1 - Uses Schedule		
		Percentage eligible for
tes of Funds Capital Investment	Amount (USD) 0.00	
Copital Investment 1a: Land acquisition (incl. appraisal costs, right of-way acquisitions, relocation expenses) Land acquisition (incl. appraisal costs, right of-way acquisitions, relocation expenses) Land improvements and site restoration (including dentalition and removal)	0.00	
Land improvements and site restoration (including demolition and removal) [Insert description]		
[Insert description] [Insert description]		
(Insert description) (Insert description)		
(Insert description)		
1.b. Construction	0.00	
Budforg - Liber Budforg - Newsrian Budforg - Newsrian Dimer of description Dimer des		
[Insert description]		
(Insert description) (Insert description)		
[Insert description] [Insert description]		
1.b.i Gean Room Construction Gean room construction labor	0.00	
Collection of Collections (According to Collection (According to Collec		
[Insert description] [Insert description]		
[Insert description] [Insert description]		
[Insert description] [Insert description]		
1.c. Equipment 1.c. Chan Room Level Manufacturine Equipment	0.00	
istilla unisconductor manufacturing outpresent purchase (including spare parts) serviconductor manufacturing outpresent installation [Juvar discoplants]		
[Insert description]		
(Insert description)		
(Insert description)		
1.c.ii Interstitial and Fan Deck Equipment	0.00	
### ### ##############################	1	
(Insert description) (Insert description)		
[Insert description] [Insert description]		
(Insert description) 1.ciiii. Clean Sub-fab Level Equipment Pureps and abatement systems	0.00	
Ultrapure water systems (Insert description)		
Ultrapore water systems [sweet description] [sweet description] [sheet description] [sheet description]		
[Insert description] [Insert description]		
[Insert description] 1.c.iv Utility Level Equipment	0.00	
Bear Colonity Action recognition		
[Insert description]		
[Insert description]		
(Insert description) 1.c. Volume Stand-alone Facilities Equipment FAO For inserts	0.00	
1.4. Doll a facilità del con primeri e de polyacione Mal Conginerer Deser d'acceptione Deser d'acception Deserved d'acception Deserved d'acception Deserved d'acception Deserved d'acception Deserved d'acception Deserved d'acception D		
(Insert description)		
(Insert description)		
[Insert description]	0.00	_
Description (Incomplete) Extra Description (Incomplete) Extra Description (Incomplete) Extra Description (Incomplete) Extra Description (Incomplete)		
Ramp - Technology Transfer		
(Insert description)		
(Insert description) (Insert description)		
[Insert description] [Insert description]		
[hreart description] 1.d. Infrastructure improvements Ernergy Infrastructure Ernergy Infrastructure	0.00	
Energy Infrastructure Wastewater treatment plants		
Energy plantanetume Washensider teathernst plants Acress with mit sections (e.g., routh) Acress with mit sections (e.g., routh) [Invariance of the plantanetum (e.g., routh) [Invariance of the plantanet		
[Insert description]		
(Insert description) (Insert description)		
		_
[Inner discoption] As Administrative Expenses directly attributable to facility construction Administrative fore (e.g., [e.g.], licensing and permitting, imposition, bond) Architecture and Erriprensing fees Safety and environmental protection costs Costs associated with receiving CIPSE fording	0.00	
Architecture and Engineering fees Safety and environmental protection costs		
[Insert description] [Insert description]		
[Insert description] [Insert description]		
[Insert description]		
[Insert description] 1.f. Other [Insert description] [Insert description]	0.00	
[Insert description] [Insert description]		
Immert description		
(Insert description) (Insert description)		
perior acceptor) perior deceptor) perior deceptor perior deceptor perior deceptor perior deceptor perior pe	0.00 0.00	
Equipment Costs Construction of Training Center		
Equipment Cash Construction of Training Center Training and Education Costs Whop, Around Support Costs Children Costs Planer Georgian Planer discuplient) Planer discuplient) Planer discuplient)		
Childrane Costs Assert description		
[Insert description]		
	1	
Description		
Instant intercologically	0.00	
[Insert description]		
(Insert description) (Insert description)	1	
(insert description)	1	
[Insert description] [Insert description]		

chedule B: Project 1 - Funding Sources Schedule	
ources of Funds	Amount (USD)
Equity Funding	0.00
Sponsor Equity (Applicant and/or Corporate Parent)	
Third-Party Equity	
Other Equity Funding	
[Insert description]	
(Insert description)	
[Insert description]	
(Insert description)	
(Insert description)	
(Insert description)	
Debt Funding	0.00
Infercompany Debt from Corporate Parent	
Third-Party Debt (e.e., Bonds or Loans)	
Unguaranteed portion of Third-Party Loans Guaranteed by ORPS Program	
Other Debt Funding	
Insert description	
Insert description)	
Insert description)	
Insert description	
(Insert description)	
(Insert description)	
Government Support	0.00
OHPS Direct Funding	_
OffStom	
Third-party Loans Guaranteed by CHIPS Program	
Investment Tax Credit (estimated)	
State and Local Government Grants	
State and Local Government Loans	
State and Local Tax Credits	
Other State and Local Government Incentives	
Other Federal grants, loans or guarantees	
[Insert description]	
Other Sources of Funds (examples provided below)	0.00
Equipment Financing Sale Leaseback or Other Real Estate Financine	
Sale Leasesack or Other Heal Estate Hinaricing Customer Funding	
Insert description	
Insert description	
Insert description)	1
Insert description	1
Insert description	1
Insert description	1
otal Project Funding	0.00

1. Net sales until project breaks even on cash flow basis	0.0
Gross sales until project breaks even on cash flow basis	
Price discounts (if applicable)	
2. Total operating expenses until project breaks even on a cash flow basis	0.0
[Insert description]	
Operating Income / Losses (excluding other operating income)	0.0
3. Other operating income until project breaks even on a cash flow basis	0.0
[Insert description]	
Operating Income / Losses	0.0
4. Other cash flow items until project breaks even on a cash flow basis	0.0
Semiconductor Manufacturing Equipment Replacement through breakeven	
Upgrades / Modifications to Semiconductor Manufacturing Equipment through Breakeven	
Net Working Capital	
[Insert description]	
Earnings Before Interest and Taxes	0.0
5. Total financing costs and taxes until project breaks even on a cash flow basis	0.0
Interest Paid to Service Debt	
Payments to Third-Party Partners	
Other Financing Costs	
[Insert description]	
Corporate Taxes	- 1
Other Taxes	- 1
[Insert description]	1
[Insert description]	
(Insert description)	

chedule A: Project 2 - Uses Schedule		
ses of Funds	Amount (USD)	Percentage eligible for ITC
Capital Investment	0.00	
Lax Land Land acquisition (incl. appraisal costs, right-of-way acquisitions, relocation expenses) Land acquisition (incl. appraisal costs, right-of-way acquisitions, relocation expenses) Land improvements and site restoration (including demolition and removal)		
(Insert description)		
(Insert description) (Insert description)		
[Insurt description]		
[Insert description] [Insert description]		
	0.00	
Building - Materials (heart description)		
(Insert description) [Insert description] [Insert description] [Insert description]		
United Georgeons 1.b.i Clean Room Construction Clean room construction labor	0.00	
Clean room comburchon labor Delivery system Ugifring Capiement		
[Insert description]		
(Insert description) (Insert description)		
[Insert description] [Insert description]		
	0.00	
1.c.i Clean Room Level Manufacturing Equipment	0.00	
#24 etras (some even klamfar intering etrepreser) #25 etras (some even klamfar intering etrepreser) #26 etras (some even klamfar intering etrepreser) #26 etras (some even klamfar intering even intering etras (some etras intering		
[Insert description] [Insert description]		
(Insert description) (Insert description)		
1.c.ii frestribial and Fan Deck Equipment Decignal stine als bandler units	0.00	
Recirculating air handler units [Interest description]		
[Insert description]		
(Insert description) (Insert description)		
(Insert description) 1.ciii. Gean Sub-fab Level Equipment	0.00	
Pumps and abatement systems Prover Surply System		
Ultrapure water systems		
Furny and distincted systems Fours Supply System Ultrapure water rystems Ultrapure water rystems [Jener description] [Jener description] [Jener description]		
(insert description) [Insert description] [Insert description]		
Unsert description) 1.civ Utility Level Equipment (truert description)	0.00	
[Insert description]		
Interest description		
	0.00	
Ext Office Stand along Feedings Equipment MACT Equipment MACT Equipment Description Descri	0.00	
Prototyping Equipment (Insert description)		
[Insert description] [Insert description]		
[Insert description] [Insert description]		
[Insert description]	0.00	
Deart disordinal Stary, Hilling and printedging Europ, Philling and printedging Europ, Philling and printedging Europ, Philling and philling Europ, Philling and philling Europ, Vield Europ 10 Europ Annaphini Europhini Europhini Deart disordinal Deart disordinal Deart disordinal Deart disordinal		
Ramp - Technology Transfer		
[Insert description]		
[Insert description] [Insert description]		
[Insert description] [Insert description]		
[Insert description]	0.00	
Spend description) Group of control of the control		
Access Infrastructure (e.g., roads)		
[Insert description] [Insert description]		
[Insert description] [Insert description]		
[Insert description]		
Pared fine-principles And the state of the	0.00	
Administrative rees (e.g., regal, recenting and permitting, impection, dono) Architecture and Engineering fees		
Safety and environmental protection costs Costs associated with receiving CHIPS funding		
Insurance costs (Insert description)		
[Insert description]		
[Insert description]		
[Insert description]	0.00	
[Insert description] 1.f. Other [Insert description] [Insert description]	0.00	
[Insuert description] [Insuert description] [Insuert description] [Insuert description] [Insuert description]		
[Insert description] [Insert description]		
	ow) 0.00	
y Operating (Dassessed) Operating (Dasses and Other cash outflows until project cash flows breakeven (Complete Schedule C be: Wortforce Development Costs Equipment Costs	0.00	
Construction of Training Center		
were notice to development come Continuation of Intering Center Training and Education Cents Wasp-Aread Support Cents Childure Cents [James Georgian]		
Childrane Costs (Insert description)		
Description		
[Insert description] [Insert description]	1	
Filter of description Filtre of descri	- 1	
[Insert description] [Insert description] [Insert description] [Insert description] [Insert description]	0.00	
Seast discription	0.00	
Seast discription	0.00	
[Insert description] [Insert description] [Insert description] [Insert description] [Insert description]	0.00	

Schedule B: Project 2 - Funding Sources Schedule	
Sources of Funds	Amount (USD)
1. Equity Funding	0.0
Sponsor Equity (Applicant and/or Corporate Parent)	
Third-Party Equity	
Other Equity Funding	
Insert description	
(Insert description)	
(Insert description)	
Insert description	
Insert description	
Insert description	
2. Debt Funding	0.00
Intercompany Debt from Corporate Parent	0.00
Third-Party Debt (e.e., Bonds or Loans)	
Unguaranteed portion of Third-Party Loans Guaranteed by ORPS Program	
Other Debt Funding	
Insert description	
Insert description	
Insert description	
(Insert description)	
(Insert description)	
Insert description	
3. Government Support	0.00
OHPS Direct Funding	
CHPS Loans	
Third-party Loans Guaranteed by CHIPS Program	
Investment Tax Credit (estimated)	
State and Local Government Grants	
State and Local Government Loans	
State and Local Tax Credits	
Other State and Local Government Incentives	
Other Federal grants, loans or guarantees	
[Insert description]	
[Insert description]	
(Insert description)	
Insert description	
I. Other Sources of Funds (examples provided below)	0.00
Equipment Financine	0.00
Sole Leaseback or Other Real Estate Financine	
Customer Funding	
(Insert description)	
[Insert description] [Insert description]	
[Insert description] [Insert description] [Insert description] [Insert description]	
[Insert description] [Insert description] [Insert description] [Insert description] [Insert description]	
[Insert description] [Insert description] [Insert description] [Insert description]	0.00

1. Net sales until project breaks even on cash flow basis	0.
Gross sales until project breaks even on cash flow basis	
Price discounts (if applicable)	
2. Total operating expenses until project breaks even on a cash flow basis	0.
[Insert description]	
[Insert description]	1
[Insert description]	
Operating Income / Losses (excluding other operating income)	0.
3. Other operating income until project breaks even on a cash flow basis	0.
[Insert description]	
[Insert description]	1
[Insert description]	1
[Insert description]	
[Insert description]	1
[Insert description]	
Operating Income / Losses	0.
L Other cash flow items until project breaks even on a cash flow basis	0.
Semiconductor Manufacturing Equipment Replacement through breakeven	1
Upgrades / Modifications to Semiconductor Manufacturing Equipment through Breakeven	1
Net Working Capital	
[Insert description]	1
[Insert description]	
[Insert description]	
Earnings Before Interest and Taxes	0.
5. Total financing costs and taxes until project breaks even on a cash flow basis	0.
Interest Paid to Service Debt	1
Payments to Third-Party Partners	1
Other Financing Costs	
[Insert description]	
[Insert description]	1
[Insert description]	1
[Insert description]	1
[Insert description]	
[Insert description]	1
Corporate Taxes	1
Other Taxes	1
[Insert description]	1
[Insert description]	1

		Percentage
tes of Funds Capital Investment	Amount (USD)	Percentage eligible for
	0.00	
Land acquisition (incl. appraisal costs, right-of-way acquisitions, relocation expenses) Land improvements and site restoration (including demolition and removal)		
(insert description)		
[insert description]		
[Insert description] [Insert description]		
(insert description)		
[Insert description] 1.b. Construction	0.00	_
Building - Labor	0.00	_
Building - Materials		
(Insert description) (Insert description)		
(Insert description)		
[Insert description] [Insert description]		
[Insert description]		
1.b.i Clisan Room Construction Clisan room construction labor	0.00	
Delivery systems		
Ughting Equipment		
(Insert description)	- 1	
(Insert description) [Insert description]	- 1	
(Insert description)	- 1	
[Insert description]	0.00	_
1.c.i Clean Room Level Manufacturing Equipment	0.00	
Initial semiconductor manufacturing equipment purchase (including spare parts) Semiconductor manufacturing equipment installation	- 1	
(insert description)		
(Insert description) (Insert description)		
[Insert description]		
1.c.ii Interstitial and Fan Deck Equipment	0.00	
Recirculating air handler units (Insert description)		
(Insert description)		
[Insert description] [Insert description]		
[Insert description]		
1.c.II. Clean Sub-fab Level Equipment	0.00	_
Pumps and abatement systems		
Power Supply System Ultrapure water systems		
(insert description)		
(insert description) (insert description)		
[Insert description]		
(insert description) (insert description)		
1.c.lv Utility Level Equipment	0.00	
(Insert description)		
(Insert description)		
(Insert description) [Insert description]		
(insert description)		
1.c.v Other Stand-alone Facilities Equipment REO Equipment	0.00	
	1	
(Insert description)	- 1	
(Insert description)	- 1	
(Insert description) (Insert description)	- 1	
L.c.vi Ramp Ramo - Pitolina and Prototypina	0.00	
Ramo - Process Engineering / Foundry Enablement	1	
Ramp - Technology Transfer Ramp - Yield Ramp Up	- 1	
(insert description)	1	
[Insert description] [Insert description]	1	
(Insert description)	1	
[Insert description] [Insert description]		
1.d. Infrastructure Improvements	0.00	
Energy infrastucture Wastewater treatment plants		
Access Infrastructure (e.g., roads)	- 1	1
(Insert description) (Insert description)	1	
(Insert description)	- 1	1
[Insert description] [Insert description]	1	
(Insert description)		
Administrative Expenses directly attributable to facility construction Administrative fees (e.g., legal, licensing and permitting, inspection, bond)	0.00	
Architecture and Engineering fees	- 1	
Safety and environmental protection costs Costs associated with receiving CHPS funding	1	
Invurance costs	- 1	
(Insert description)	1	
(Insert description) (Insert description)	- 1	1
[insert description]	1	
(Insert description) (Insert description)	- 1	
1.f. Other	0.00	

urces of Funds	Amount (USD)
Equity Funding	0.00
Sponsor Equity (Applicant and/or Corporate Parent)	
Third-Party South	l .
Other Equity Funding	
[insert description]	l .
(Insert description)	
(Insert description)	l .
(Insert description)	l .
(Insert description)	
	l .
[Insert description]	
Debt Funding	0.00
Intercompany Debt from Corporate Parent	
Third-Party Debt (e.g., Bonds or Loans)	
Unguaranteed portion of Third-Party Loans Guaranteed by CHIPS Program	
Other Debt Funding	l .
[Insert description]	
[Insert description]	
[Insert description]	
[Insert description]	l .
[Insert description]	
[Insert description]	
Government Support	0.00
CHIPS Direct Funding	
CHIPS Learns	
Third-party Loans Guaranteed by CHIPS Program	
Investment Tax Credit (estimated)	
State and Local Government Grants	l .
State and Local Government Loans	
State and Local Tax Credits	
Other State and Local Government Incentives	l .
Other Federal grants, loans or guarantees	
[Insert description]	l .
[Insert description]	
	l .
[Insert description]	
Other Sources of Funds (examples provided below)	0.00
Uther sources or Funds (examples provided below) Louisment Financine	0.00
Sale Leaseback or Other Real Estate Financing	
Customer Funding	
[insert description]	l .
[insert description]	
[insert description]	ı
[insert description]	
[insert description]	ı
[Insert description]	
tal Project Funding	0.00
	•

until project cash flows breakeven (Complete Schedule C below 0.00

	Amount (USD)
I. Net sales until project breaks even on cash flow basis	0.00
Gross sales until project breaks even on cash flow basis	
Price discounts (if applicable)	
2. Total operating expenses until project breaks even on a cash flow basis	0.0
[insert description]	
(Insert description)	
[insert description]	
(Insert description)	
(Insert description)	
(Insert description)	
Operating Income / Lauses (excluding other operating Income)	0.0
Other operating income until project breaks even on a cash flow basis	0.0
[insert description]	
[insert description]	
(Insert description)	1
(Insert description)	
(Insert description)	
(Insert description)	
Operating Income / Lauses	0.0
K. Other cash flow items until project breaks even on a cash flow basis	0.0
Semiconductor Manufacturing Equipment Replacement through breakeven	
Upgrades / Modifications to Semiconductor Manufacturing Equipment through Breakeven	
Net Working Capital	
(Insert description)	
(Insert description)	
[insert description]	
(Insert description)	
(Insert description)	
(Insert description)	
Cornings Before Interest and Taxes	0.0
5. Total financing costs and tases until project breaks even on a cash flow basis	0.0
Interest Paid to Service Debt	
Payments to Third-Party Partners	
Other Financing Costs	
(Insert description)	1
Corporate Taxes	
Corporate Taxes Other Taxes	
Corporate Taxes Other Taxes [Insert description]	
Corporate Taxes Other Taxes	

Question 1: Provide an explication on how the equity placeted into the projects logic rettly by the applicant, its corporate power is this pure partnered in trade of their changes of their corporate power for this purp partnered in trade of their changes of their corporate power for with pulsary partners in balance and explication of the provide details on the amount of deal antifuscable to this project.

Question 2: Explain how you estimated the value of the benefit from the investment Tax Credit. Quantities if an inform are retires after a local transfoliate that provide handing in a form that has a disent great a law, such propose, and the provide hand the second second